

L Number	Hits	Search Text	DB	Time stamp
-	3	("6405429").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 19:58
-	4	"PI-2570"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:11
-	2	release with "polyimide parylene"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:41
-	219288	peel\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:41
-	121512	polyimide parylene	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:42
-	1029	release with (polyimide parylene)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:42
-	7683345	layer material film	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:43
-	7948347	((layer material film) coating	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:46
-	412	((release adj ((layer material film) coating)) with (polyimide parylene)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:48
-	218	((release adj ((layer material film) coating)) near5 (polyimide parylene)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:50
-	4092275	@ad>19990825 @rlad>19990825 @ptld>19990825	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:50
-	0	((release adj ((layer material film) coating)) with (polyimide parylene)) with (platinum pt palladium pd)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:51

-	1427	(polyimide parylene) with (platinum pt palladium pd)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:51
-	5	release with ((polyimide parylene) with (platinum pt palladium pd))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:52
-	4	(release with ((polyimide parylene) with (platinum pt palladium pd))) not (@ad>19990825 @rlad>19990825 @pt1d>19990825)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:52
-	23	peel\$ with ((polyimide parylene) with (platinum pt palladium pd))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:53
-	18	(peel\$ with ((polyimide parylene) with (platinum pt palladium pd))) not (@ad>19990825 @rlad>19990825 @pt1d>19990825)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:53
-	162	((release adj ((layer material film) coating)) near5 (polyimide parylene)) not (@ad>19990825 @rlad>19990825 @pt1d>19990825)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:57
-	122590	photoresist	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 20:57
-	9	((release adj ((layer material film) coating)) near5 (polyimide parylene)) not (@ad>19990825 @rlad>19990825 @pt1d>19990825) with photoresist	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 21:10
-	0	pirl with (platinum pt palladium pd)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 21:10
-	180	pirl	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 21:10
-	157	pirl not (@ad>19990825 @rlad>19990825 @pt1d>19990825)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 21:11
-	13	pirl with photoresist	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 21:17

-	13	(pirl with photoresist) not (@ad> 19990825 @riad>19990825 @pt1d> 19990825)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/04 19:50
-	33798	release adj ((layer material film) coating)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/04 21:28
-	309	(platinum pt palladium pd) with (release adj ((layer material film) coating))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/04 21:28
-	1	((platinum pt palladium pd) with (release adj ((layer material film) coating))) with etch\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/04 21:30
-	958156	release	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/04 21:31
-	1457450	platinum pt palladium pd	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/04 21:31
-	453729	etch\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/04 21:31
-	5907	(platinum pt palladium pd) with etch\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/04 21:31
-	6	release with ((platinum pt palladium pd) with etch\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/04 21:31
-	774	(platinum pt palladium pd) near etch\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/04 21:37
-	2	("4784972").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/06 21:33
-	6	005633.ap.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/07 18:33

-	1457909	platinum pd palladium pt	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/07 19:28
-	0	(platinum pd palladium pt) and (("5665648").PN.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/07 19:29
-	2	("5665648").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/07 20:50
-	17	tape! adj automated adj bonding adj carrier	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/07 20:51